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To: Messrs. Epping Hermann Fischer Patentanwaltsgesellschaft mbH Application No. 89113563

English language translation for the Publication number 155504

Publication date: April 1, 1991

Title: Tape Adhesive and Packaging Apparatus for Golden Fingers of

Application number: 79210837 Filing date: September 27, 1990 Applicant: Acer Computer Co., Ltd

Claim 1

A tape adhesive and packaging apparatus for golden fingers of PCB, comprising

a main body;

a control device, mounted on the main body;

a roller PCB transporting device, mounted on the main body;

a first tape adhesive and packaging device, mounted on the main body and controlled by the control device, for adhering and packaging a tape on a surface of the golden finger of the PCB delivered by the transporting device:

a tape cutting device, mounted on the first tape adhesive and packaging device and controlled by the control device, for cutting the tape adhered and packaged on the surface of the golden finger in a

predetermined length, and

a second tape adhesive and packaging device, mounted on the main body, for adhering and packaging a tape on a surface of the golden finger of the PCB where has not been adhesive and packaged.

Brief Description of Drawings

- Fig. 1 is a schematic drawing showing tape adhesion and package on the lower surface of the golden finger of PCB,
- Fig. 2 is a schematic drawing showing the tape in a case of cutting;
- Fig. 3A and 3B are structural and operation drawings showing portion of the cutting tool; and
- Fig. 4 is a schematic drawing showing tape adhesion and package on the lower surface of the golden finger of PCB.

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(54)名

([21] 申 語

全

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利 報. 11) 公告编辑: 155504 Publication N (::1 | nt ! | 5 4) 中華民國80年(1891) 04月01日 HOSK 3/00 (51) Int - C1 - : H05K

值: 印刷有路板金平指贴带贴卸装置 Title

据复数: 79210837 Applicestion No: (72) SV

(22)中新日期:中華風觀78年(1990)09月27日 Filing date

快剧旅运巡岛林村 中安岛三四七號

左转电极股份有限公司 (171)申 -: Acer

,依回既能逐渐三二五一四身体行中毁器三四七號

(74)H

[57] 申請專利範國:

1.一性印刷電路板金手指磨磨貼封裝置,包 括哲:

一主記:

一控制裝置:其裝戰於主帽上:

一波精大印刷電路板輸送裝置,其裝監於 5 主體上:

第一羅南貼封裝置・其裝職於主體上,受 控制联定之控制,将由翰送装置送采印刷 電路板金手指之一表面予以贴对股带; 一层带切断装置,其装载的第一整带贴封。10. 袋置上,其受控制装置之控制,将己贴封

於金手指表面的堅用依設定的長度切斷;

第二层 問貼 對裝置,夫裝鐵於主胡上,將 由帝总铁宝过军之印刷军路板全手指尚示 比对之一百予以以外思度。

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图示范望起明:

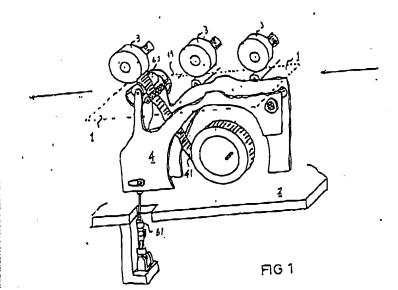
第1四为印刷电路板金手指下表面股份 贴对之示意图。

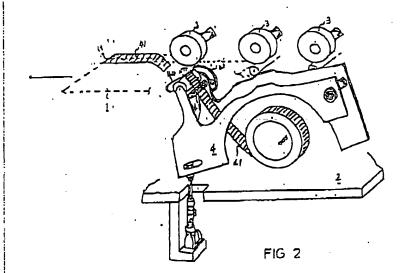
第 2 因为贴时显示被切影时之示范断。 第3(人)(月)医高切阿刀具部份之ば线 及動作图(

3.4 园为印刷宽路板会手持下表面配剂 贴封之示楚国。

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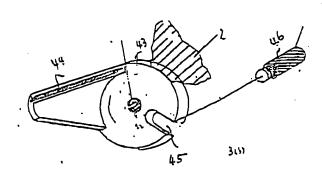
(2)

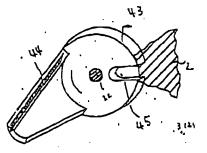




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